

# 1A, 200V - 1000V Standard Surface Mount Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low reverse leakage
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- General purpose

#### **MECHANICAL DATA**

• Case: SMAF

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 1 whisker test

Polarity: Indicated by cathode band

Weight: 0.035g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	1	Α	
$V_{RRM}$	200 - 1000	V	
I <sub>FSM</sub>	30	Α	
T <sub>J MAX</sub>	150	°C	
Package	SMAF		
Configuration	Single die		









**SMAF** 



PARAMETER		SYMBOL	S1DF-T	S1GF-T	S1JF-T	S1KF-T	S1MF-T	UNIT
Marking code on the device			S1DF	S1GF	S1JF	S1KF	S1MF	
Repetitive peak reverse voltage		$V_{RRM}$	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I <sub>F</sub>	1			Α		
Surge peak forward current single half sine-		1	30				Α	
wave superimposed on rated load	t = 1.0ms	IFSM			90			Α
Junction temperature		TJ	-55 to +150		°C			
Storage temperature		T <sub>STG</sub>	-55 to +150		°C			

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	15	°C/W	
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	89	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	22	°C/W	

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 0.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.89	-	V
	$I_F = 1.0A, T_J = 25^{\circ}C$		0.94	1.10	V
	$I_F = 0.5A, T_J = 125^{\circ}C$		0.76	-	V
	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C		0.83	0.93	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	5	μΑ
	T <sub>J</sub> = 125°C		-	150	μΑ
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	7	-	pF

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
S1xF-T	SMAF	7,500 / Tape & Reel	

#### Notes:

1. "x" defines voltage from 200V(S1DF-T) to 1000V(S1MF-T)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

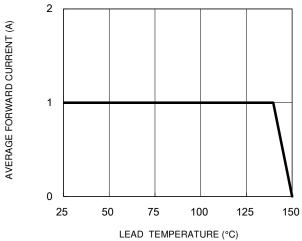


Fig.3 Typical Reverse Characteristics



Fig.2 Typical Junction Capacitance

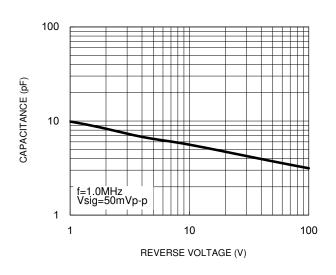
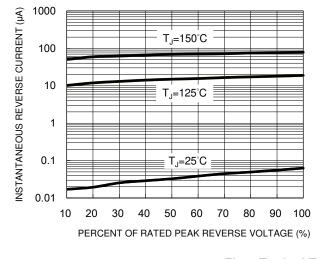


Fig.4 Typical Forward Characteristics



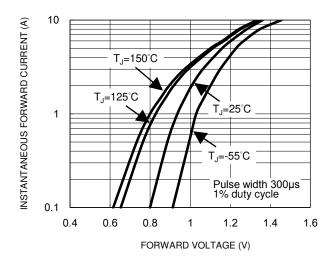
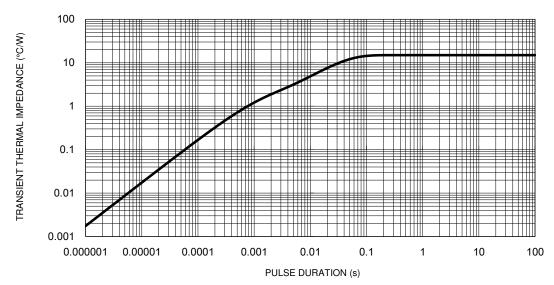
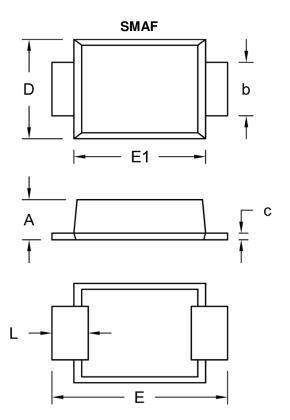


Fig.5 Typical Transient Thermal Impedance



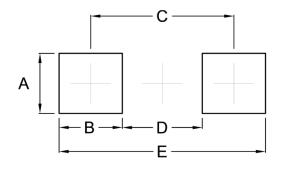


# **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.
А	1.00	1.10	0.039	0.043
b	1.30	1.50	0.051	0.059
С	0.10	0.25	0.004	0.010
D	2.40	2.80	0.094	0.110
E	4.40	4.80	0.173	0.189
E1	3.25	3.65	0.128	0.144
L	0.70	1.20	0.028	0.047

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
А	1.57	0.062
В	1.66	0.065
С	3.76	0.148
D	2.10	0.083
E	5.42	0.213

# **MARKING DIAGRAM**



P/N = Marking Code

G = Green Compound

YW = Date Code

F = Factory Code



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